

# ESE370: Circuit-Level Modeling, Design, and Optimization for Digital Systems

---

Lec 30: November 19, 2021

Inductive Noise



# Today

---

- ❑ Inductive Responses
- ❑ Calculating L
- ❑ Where inductances show up
- ❑ Impact of inductance on digital circuits
- ❑ How to address inductive noise

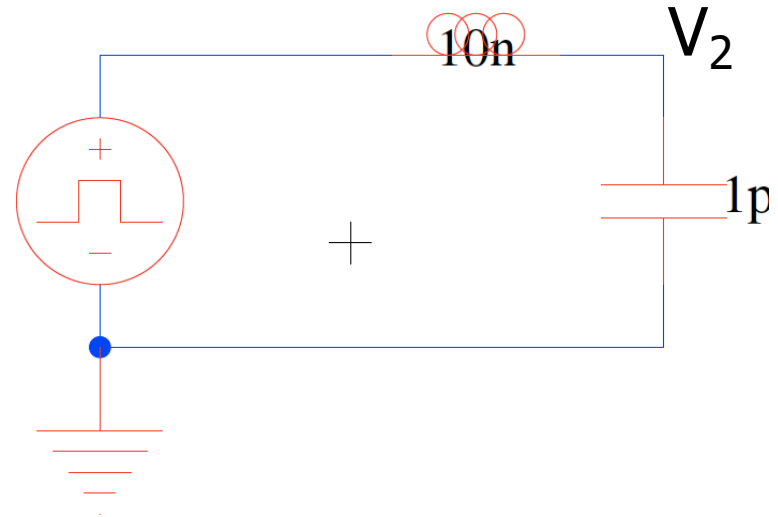


# LC Response (preclass 1)

□ What happens here?

$$L \frac{dI_L}{dt} = V_L$$

$$I_C = C \frac{dV_C}{dt}$$





# LC Response

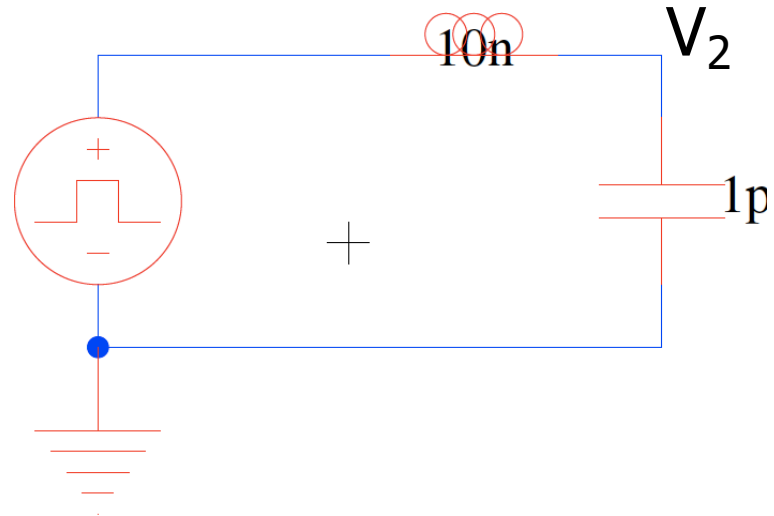
□ What happens here?

$$L \frac{dI_L}{dt} = V_L \quad I_C = C \frac{dV_C}{dt}$$

$$L \frac{dI}{dt} + V_2 = V_S$$

$$I = C \frac{dV_2}{dt} \Rightarrow \frac{dI}{dt} = C \frac{d^2V_2}{dt^2}$$

$$LC \frac{d^2V_2}{dt^2} + V_2 = V_S$$

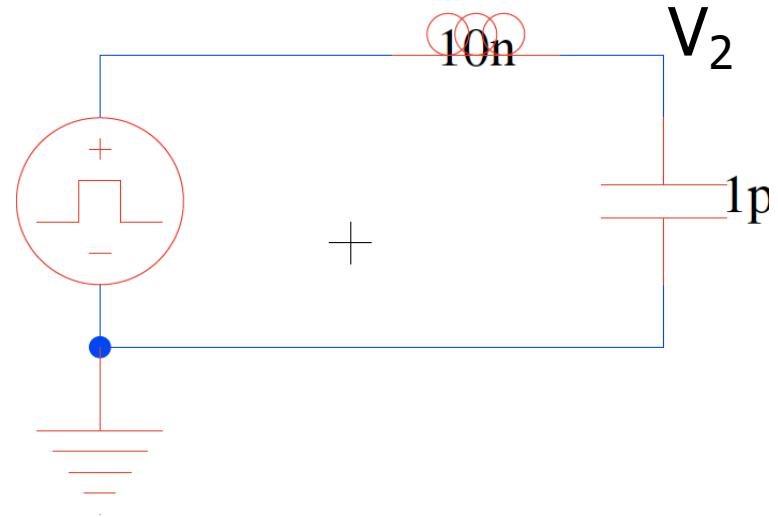




# LC Response

□ What happens here?

$$LC \frac{d^2 V_2}{dt^2} + V_2 = V_S$$





# LC Response

□ What happens here?

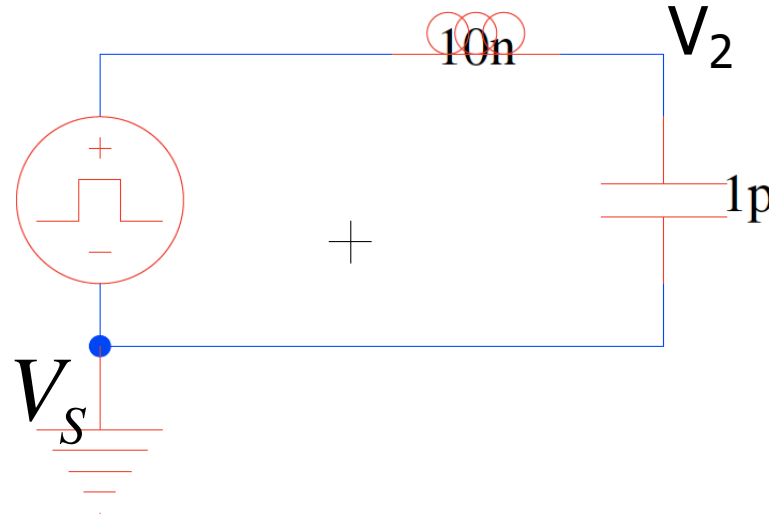
$$LC \frac{d^2 V_2}{dt^2} + V_2 = V_S$$

$$LC(-\omega^2 B e^{j\omega t}) + A + B e^{j\omega t} = V_S$$

$$A = V_S$$

$$-LC\omega^2 B + B = 0 \Rightarrow$$

$$\omega = \sqrt{\frac{1}{LC}}$$



$$V_2 = A + B e^{j\omega t}$$

$$\frac{d^2 V_2}{dt^2} = -\omega^2 B e^{j\omega t}$$



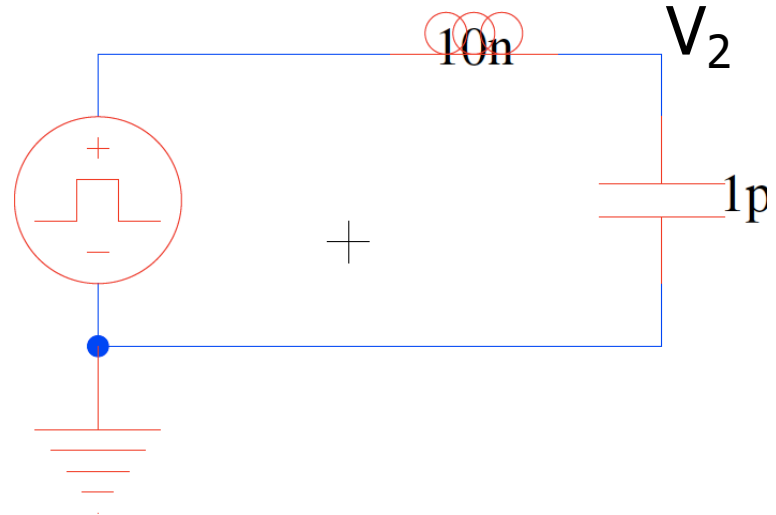
# LC Response

□ What happens here?

$$\omega = \sqrt{\frac{1}{LC}}$$

$$V_2 = A + Be^{j\omega t}$$

$$V_2 = V + Be^{j\left(\sqrt{\frac{1}{LC}}\right)t}$$

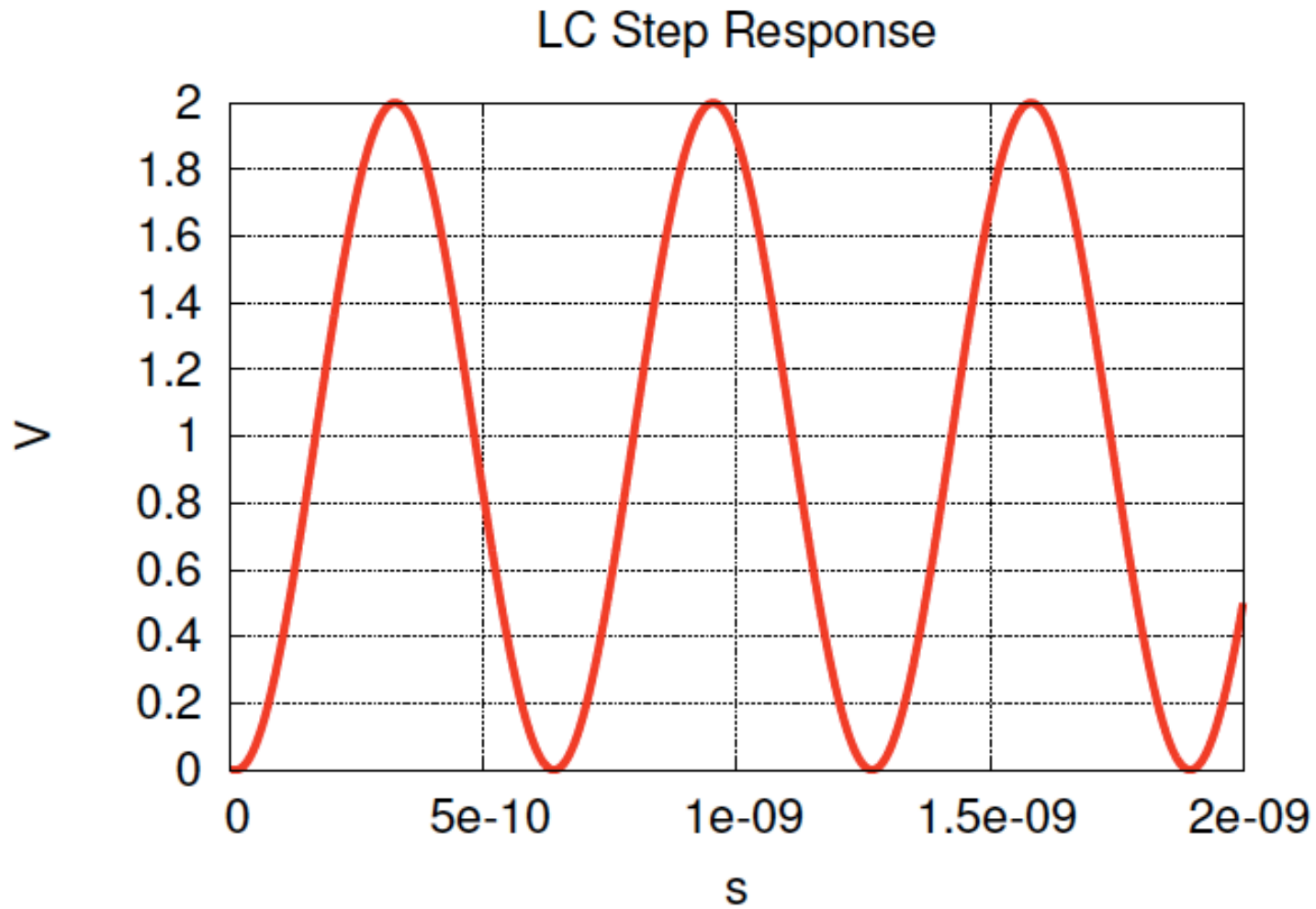


$$e^{j\theta} = \cos(\theta) + j\sin(\theta)$$



# LC Response

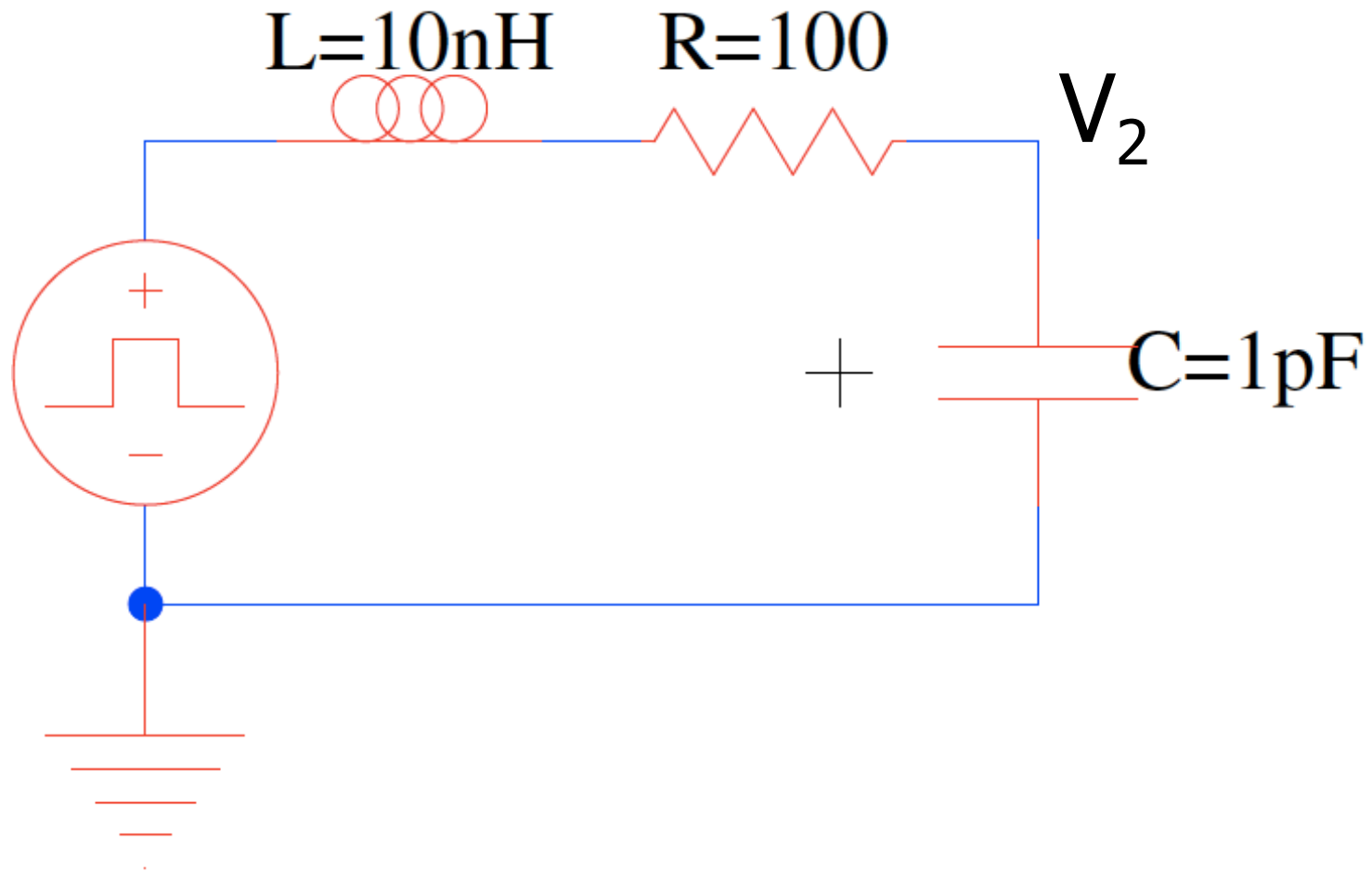
---





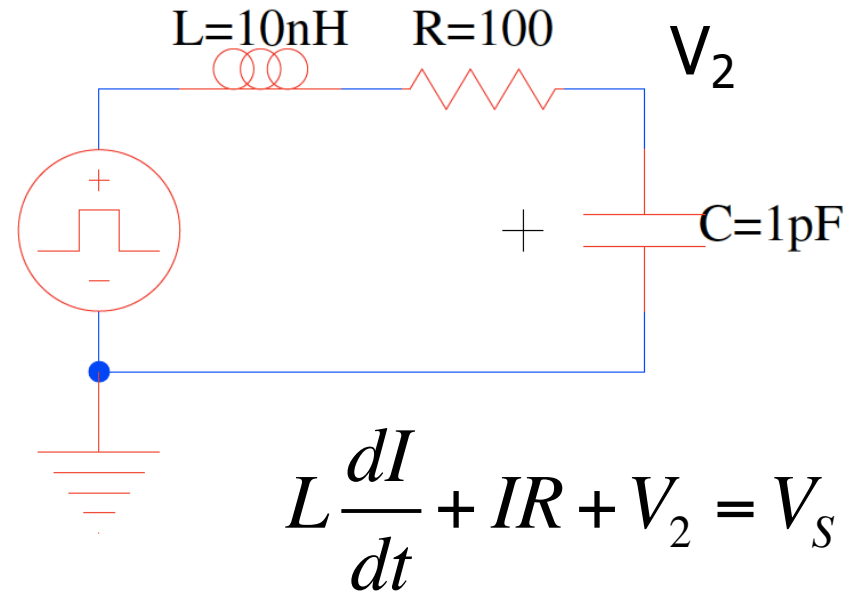


# Response? (preclass 1)





# RLC Response

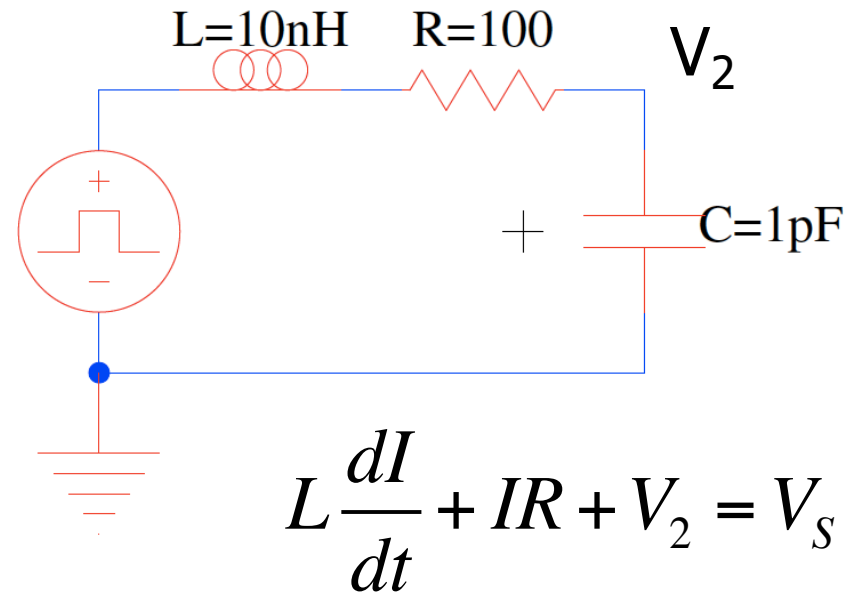


# RLC Response

$$V_2 = A + Be^{j\omega t}$$

$$\frac{dV_2}{dt} = j\omega Be^{j\omega t}$$

$$\frac{d^2V_2}{dt^2} = -\omega^2 Be^{j\omega t}$$



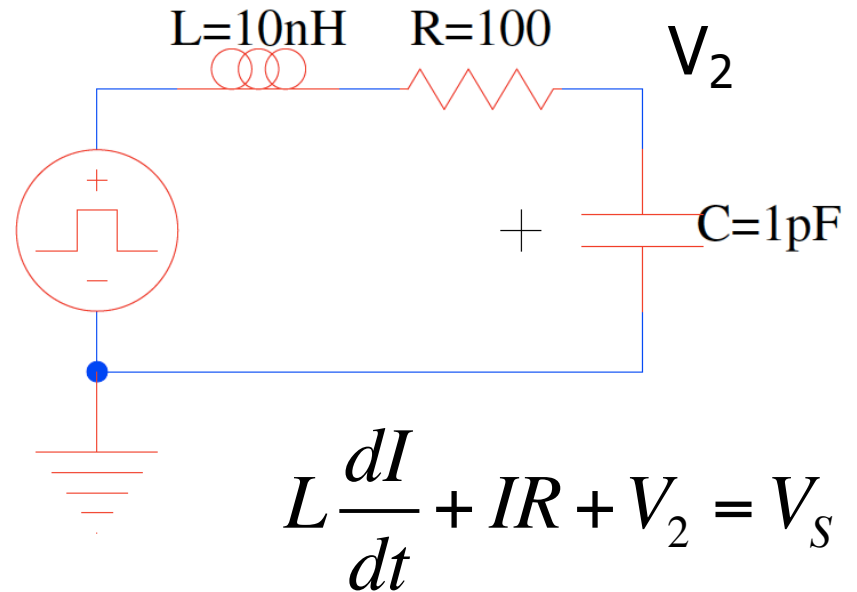
# RLC Response

$$V_2 = A + Be^{j\omega t}$$

$$\frac{dV_2}{dt} = j\omega Be^{j\omega t}$$

$$\frac{d^2V_2}{dt^2} = -\omega^2 Be^{j\omega t}$$

$$LC \left( \frac{d^2V_2}{dt^2} \right) + RC \left( \frac{dV_2}{dt} \right) + V_2 = V_S$$

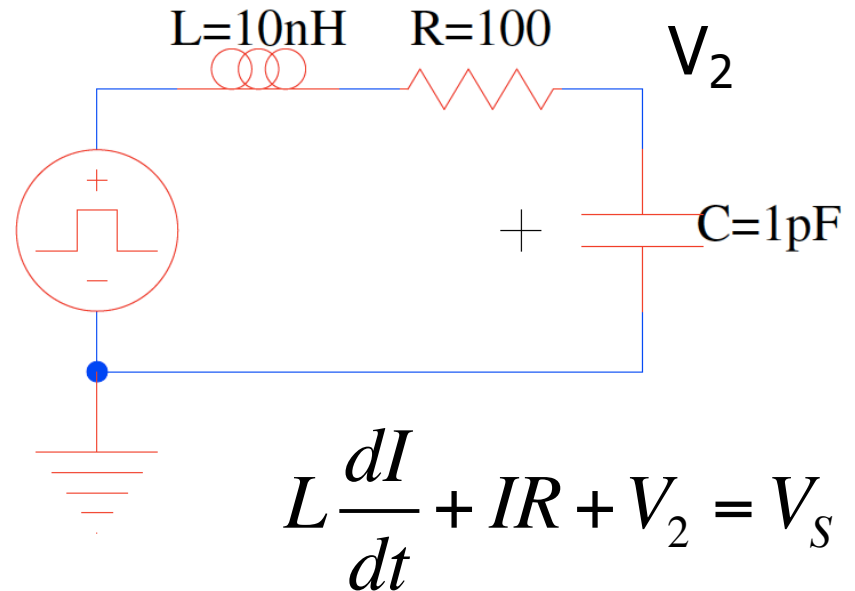


# RLC Response

$$V_2 = A + Be^{j\omega t}$$

$$\frac{dV_2}{dt} = j\omega Be^{j\omega t}$$

$$\frac{d^2V_2}{dt^2} = -\omega^2 Be^{j\omega t}$$



$$LC \left( \frac{d^2V_2}{dt^2} \right) + RC \left( \frac{dV_2}{dt} \right) + V_2 = V_S$$

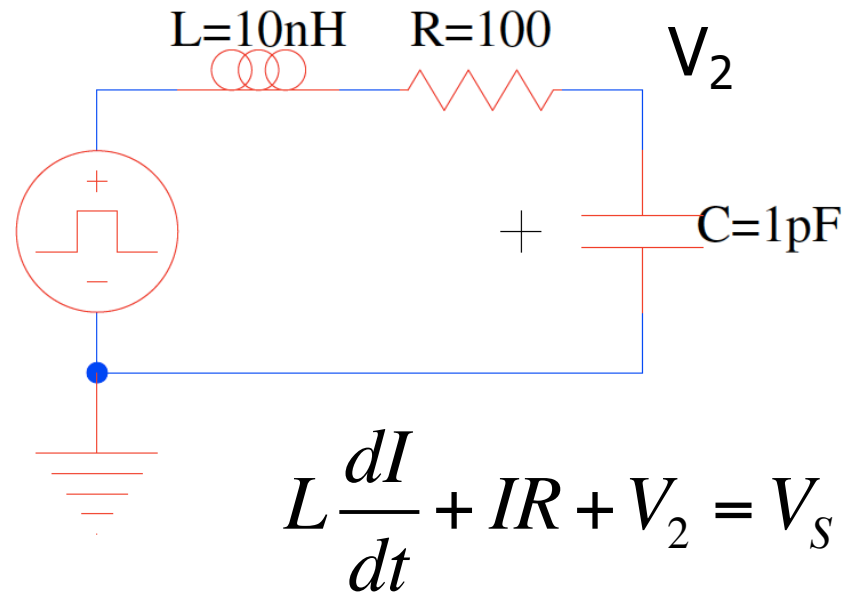
$$LC \left( -\omega^2 Be^{j\omega t} \right) + RC \left( j\omega Be^{j\omega t} \right) + A + Be^{j\omega t} = V_S$$

# RLC Response

$$V_2 = A + Be^{j\omega t}$$

$$\frac{dV_2}{dt} = j\omega Be^{j\omega t}$$

$$\frac{d^2V_2}{dt^2} = -\omega^2 Be^{j\omega t}$$



$$LC(-\omega^2 Be^{j\omega t}) + RC(j\omega Be^{j\omega t}) + A + Be^{j\omega t} = V_S$$

$$A = V_S$$

$$LC(-\omega^2) + RC(j\omega) + 1 = 0$$

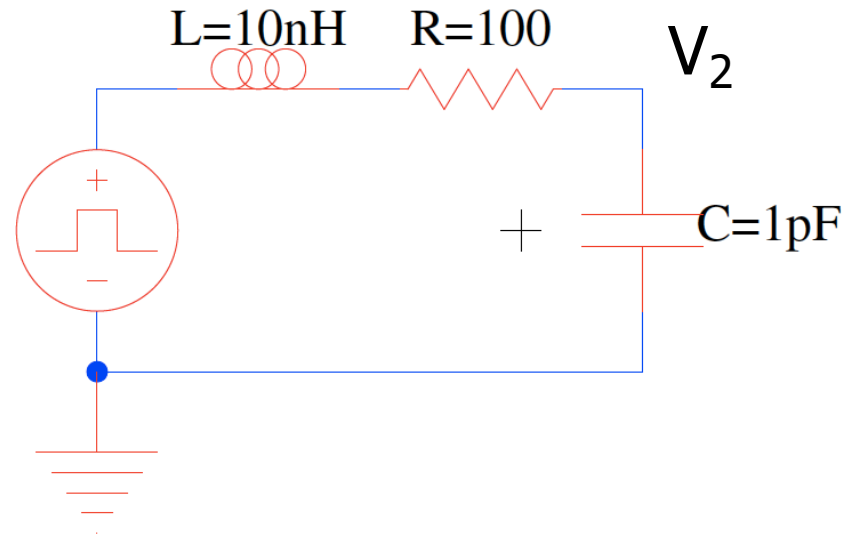
# RLC Response

$$LC(-\omega^2) + RC(j\omega) + 1 = 0$$

$$\omega^2 - j\omega \frac{R}{L} - \frac{1}{LC} = 0$$

$$\omega = \frac{j\frac{R}{L} \pm \sqrt{\left(-j\frac{R}{L}\right)^2 + \frac{4}{LC}}}{2}$$

$$\omega = j\frac{R}{2L} \pm \sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}$$



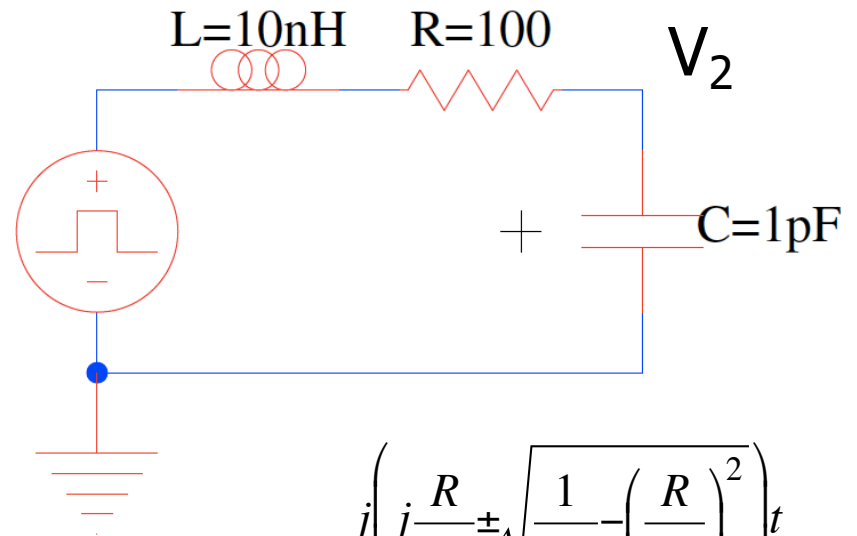
# RLC Response

$$LC(-\omega^2) + RC(j\omega) + 1 = 0$$

$$\omega^2 - j\omega \frac{R}{L} - \frac{1}{LC} = 0$$

$$\omega = \frac{j\frac{R}{L} \pm \sqrt{\left(-j\frac{R}{L}\right)^2 + \frac{4}{LC}}}{2}$$

$$\omega = j\frac{R}{2L} \pm \sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}$$



$$V_2 = V_S + B e^{j\left(j\frac{R}{2L} \pm \sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}\right)t}$$

$$V_2 = V_S + B e^{\left(-\frac{R}{2L} \pm j\sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}\right)t}$$

$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{j\sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}t}$$

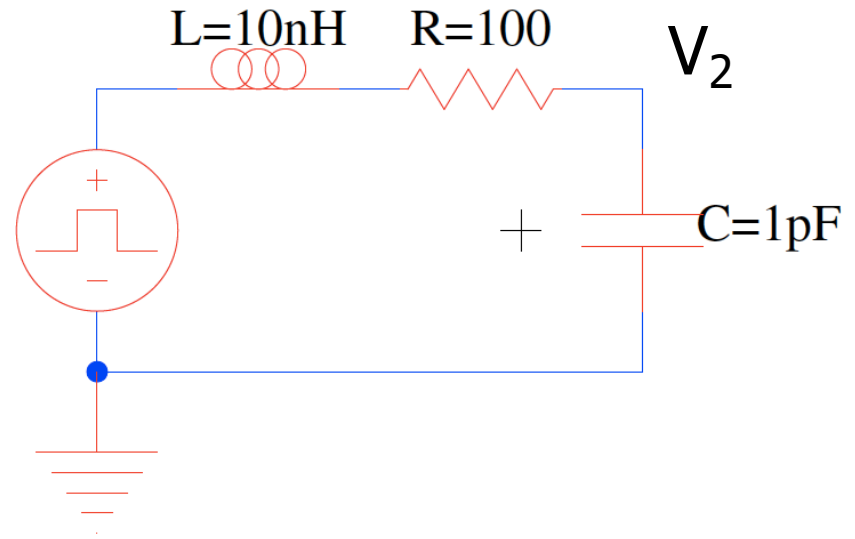




# RLC Response

$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{\left(j\sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}\right)t}$$

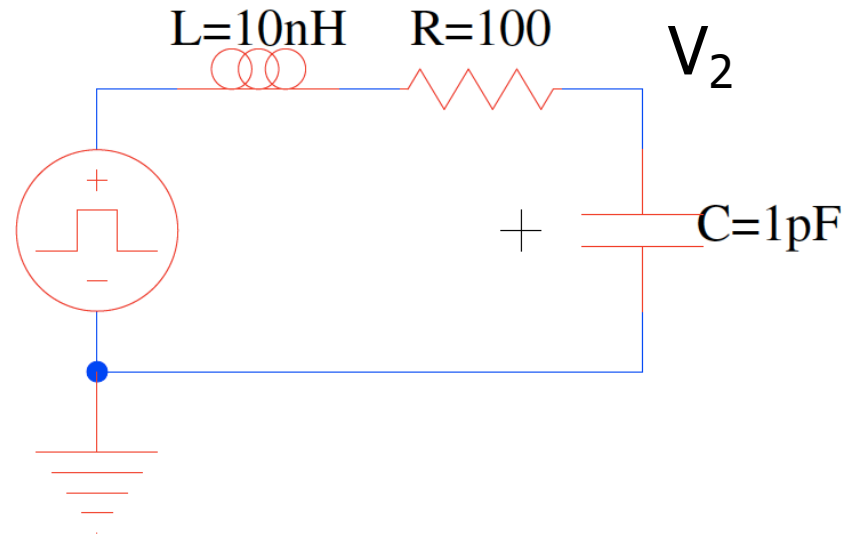
□ For what R does this circuit oscillate?



# RLC Response

$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{\left(j\sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}\right)t}$$

□ For what R does this circuit oscillate?



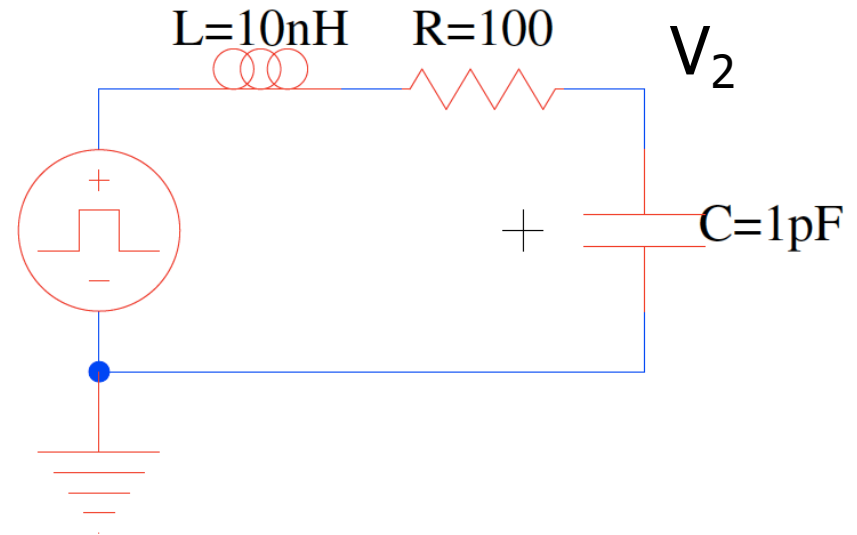
$$\frac{1}{LC} - \left(\frac{R}{2L}\right)^2 > 0$$

$$\frac{1}{LC} > \left(\frac{R}{2L}\right)^2 \Rightarrow \sqrt{\frac{4L}{C}} > R$$

# RLC Response

$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{j\sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}t}$$

Decay	Oscillation
-------	-------------



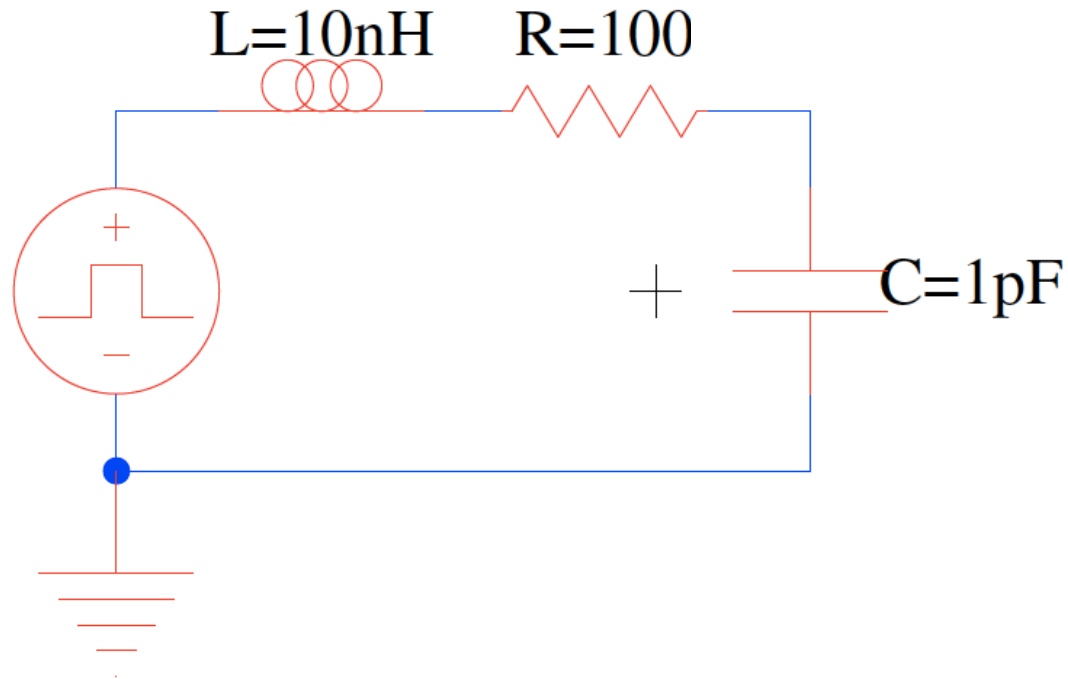
□ For what R does this circuit oscillate?

$$\frac{1}{LC} - \left(\frac{R}{2L}\right)^2 > 0$$

$$\frac{1}{LC} > \left(\frac{R}{2L}\right)^2 \Rightarrow \sqrt{\frac{4L}{C}} > R$$

# When Oscillate

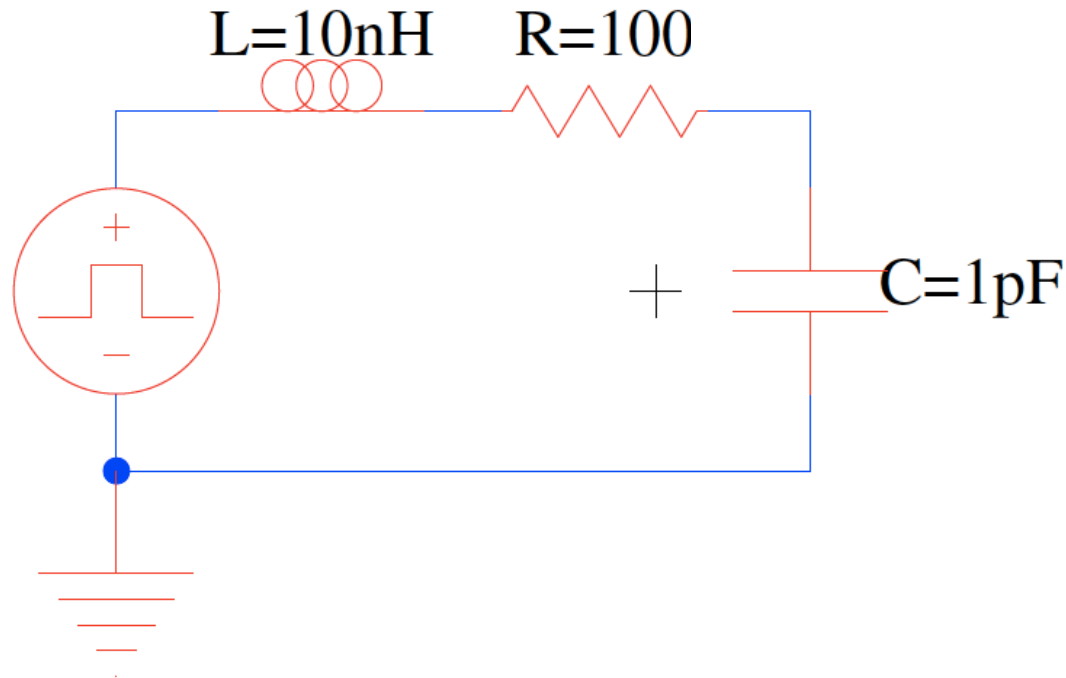
- For what  $R$  does this particular circuit oscillate?



# When Oscillate

- For what R does this particular circuit oscillate?

$$R < \sqrt{\frac{4L}{C}}$$

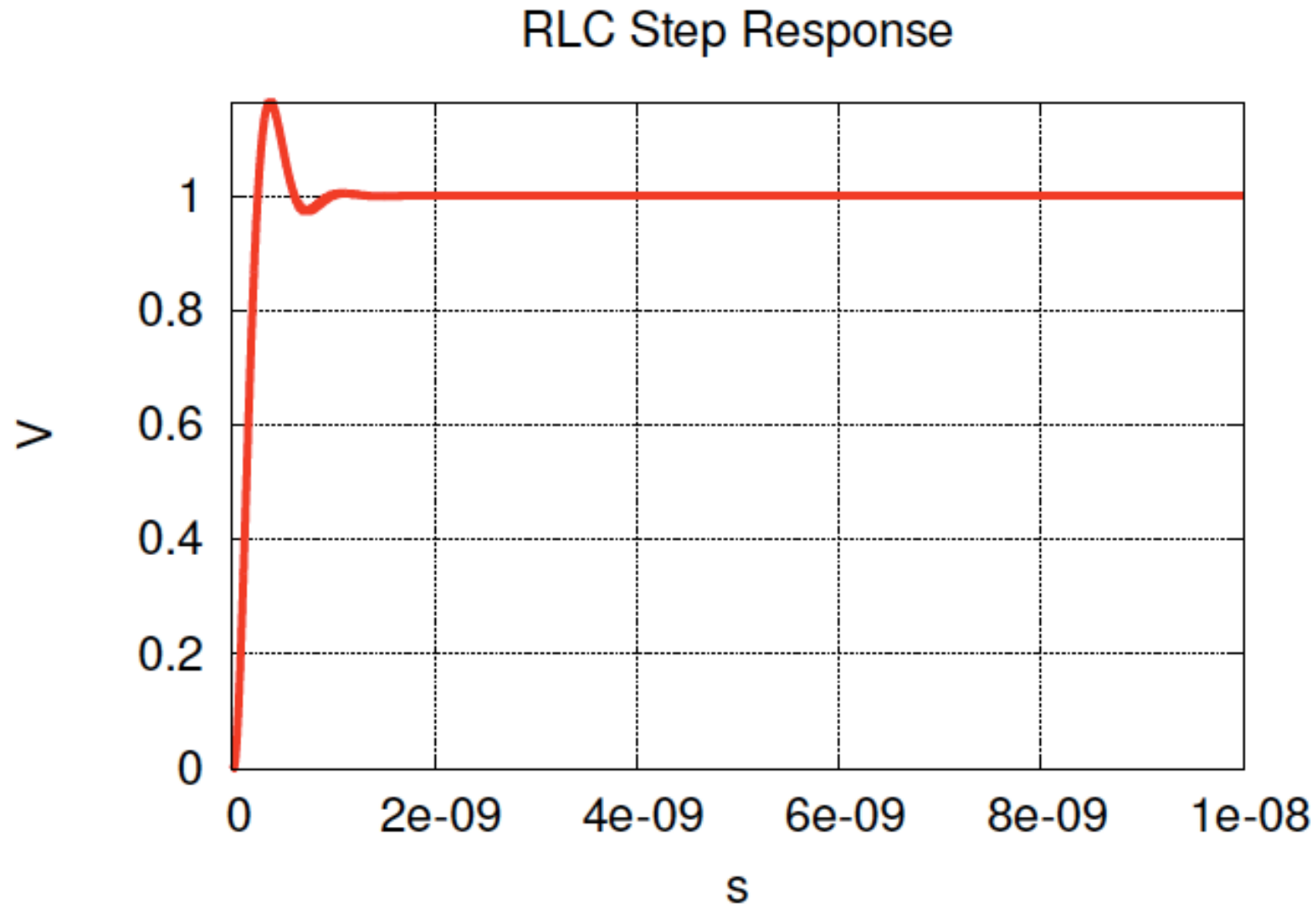


$$\sqrt{\frac{4L}{C}} = 200$$



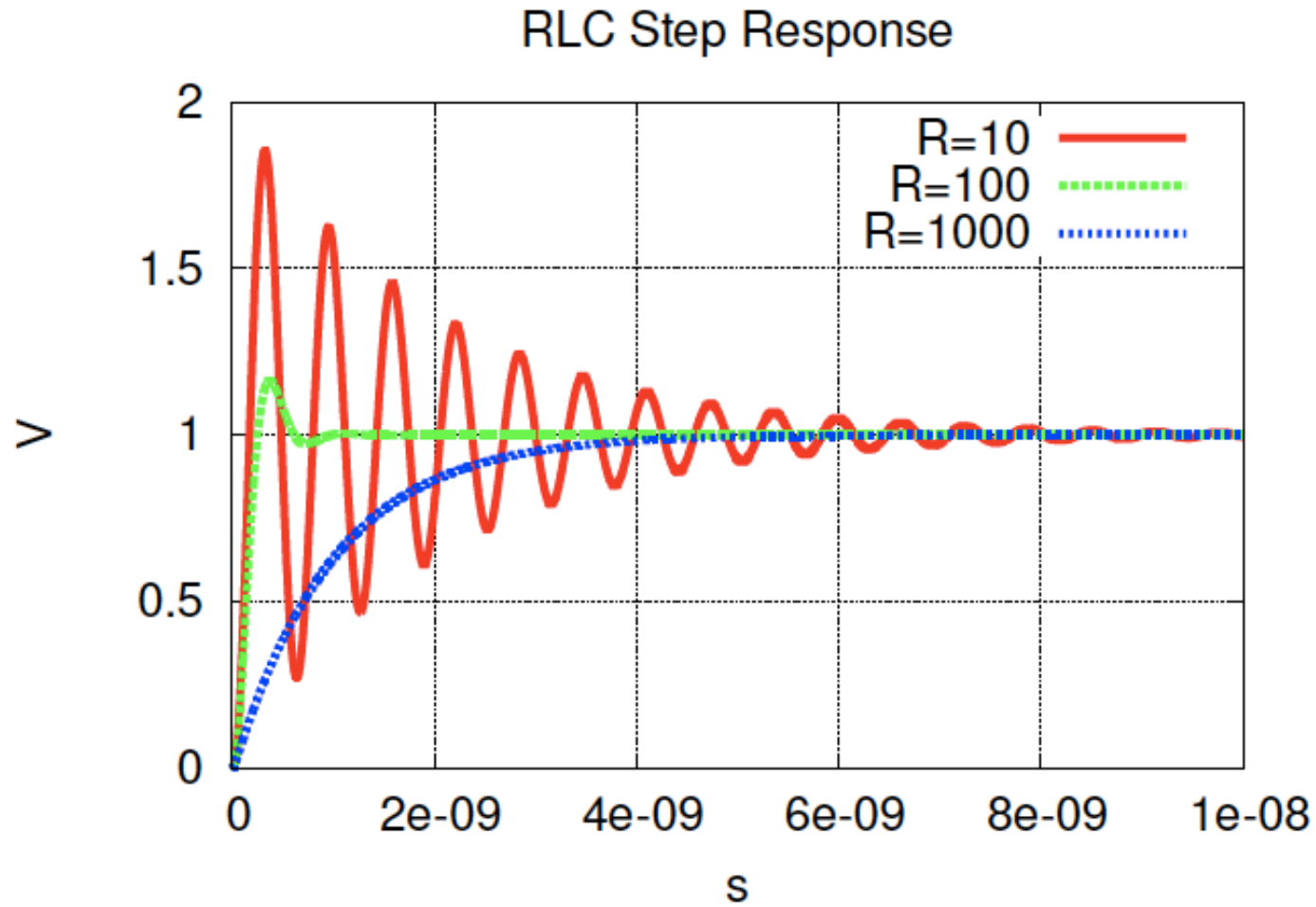
# RLC Response ( $R=100$ )

---





# RLC Response



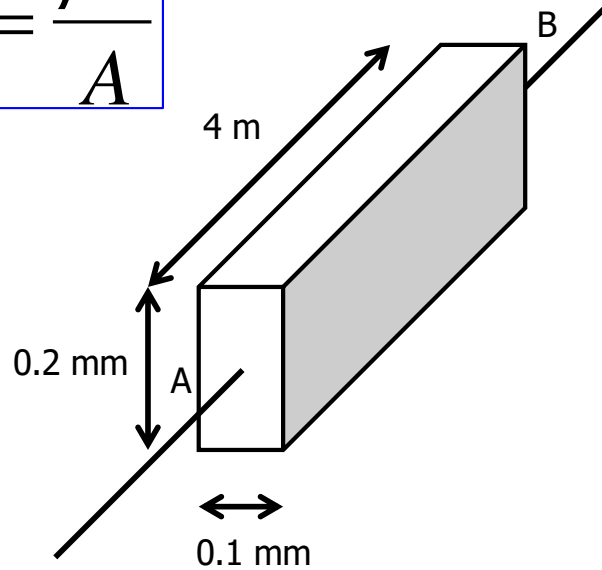
# Inductance of Wire

---

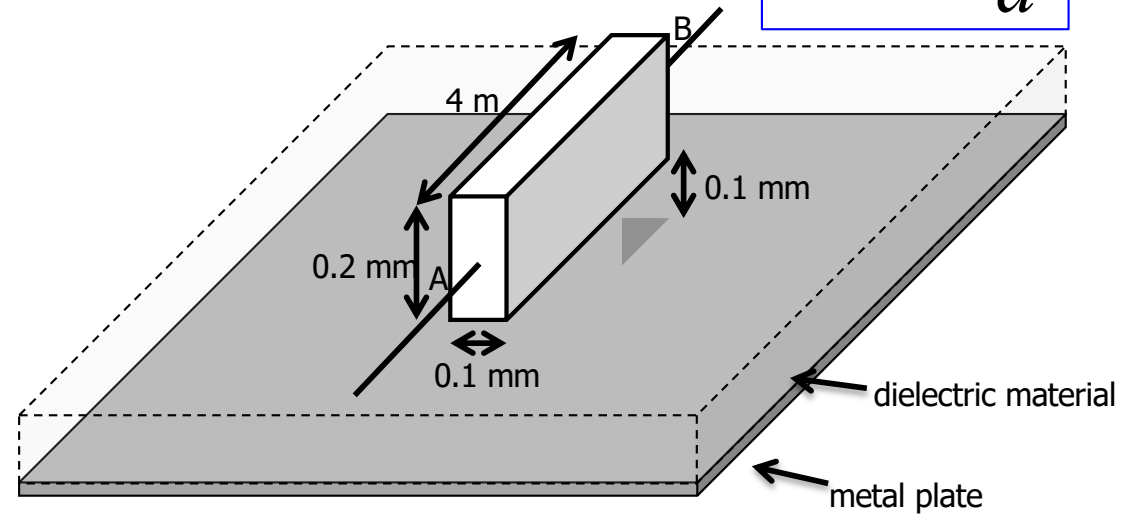


# Isolated Wire RC

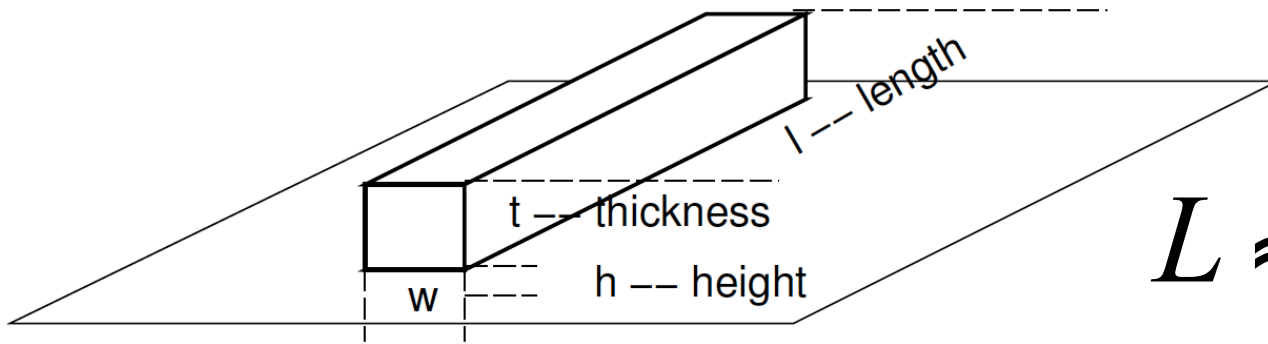
$$R = \frac{\rho L}{A}$$



$$C = \epsilon_d \frac{A}{d}$$

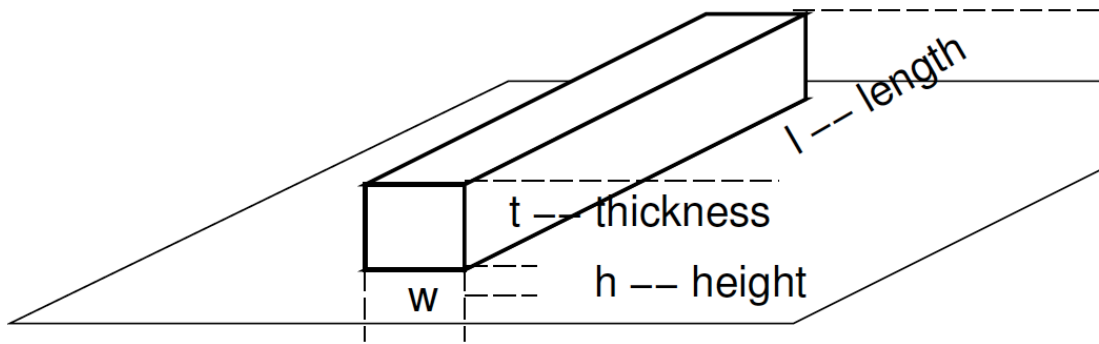


# Inductance: Wire over Ground Plane



$$L \approx l \left( \frac{\mu_0 \mu_r h}{w} \right)$$

# Inductance: Wire over Ground Plane



$$L \approx l \left( \frac{\mu_0 \mu_r h}{w} \right)$$

$$C = \epsilon_r \epsilon_0 \frac{A}{d} = \epsilon_r \epsilon_0 \frac{wl}{h} = l \left( \epsilon_r \epsilon_0 \frac{w}{h} \right)$$

# Inductance: Wire over Ground Plane

---

$$C' = \epsilon_r \epsilon_0 \frac{w}{h} \quad L' \approx \left( \frac{\mu_0 \mu_r h}{w} \right)$$

$$C' L' = \epsilon \mu$$

$C'$  and  $L'$  per unit length

$$L' = \frac{\epsilon \mu}{C'}$$



# On Chip Inductance

---

- ❑  $C_{\text{wire}} = 0.16 \text{ pF}$  (for the 1mm)
- ❑  $C_{\text{wire}} = 0.16 \text{ nF/m}$
  
- ❑ Permeability  $\mu_0 \approx \mu_{\text{SiO}_2} = 12.6 \cdot 10^{-7} \text{ H/m}$
- ❑ Permittivity  $\epsilon_{\text{ox}} = 3.5 \cdot 10^{-11} \text{ F/m}$

$$L' = \frac{\epsilon \mu}{C'}$$



# On Chip Inductance

---

- ❑  $C_{\text{wire}} = 0.16 \text{ pF}$  (for the 1mm)
- ❑  $C_{\text{wire}} = 0.16 \text{ nF/m}$
- ❑ Permeability  $\mu_0 \approx \mu_{\text{SiO}_2} = 12.6 \cdot 10^{-7} \text{ H/m}$
- ❑ Permittivity  $\epsilon_{\text{ox}} = 3.5 \cdot 10^{-11} \text{ F/m}$
- ❑ 276 pH (for 1 mm)

$$L' = \frac{\epsilon \mu}{C'}$$

# PCB Trace Inductance (preclass 2)

---

- Inductance per cm of PCB trace with  $h=3\text{mil}$ ,  
 $w=5\text{mil}$  (1mil = .001 inch)

- $\mu_0 = 1.26 \times 10^{-6}$

- $\mu_r = 1$

$$L \approx l \left( \frac{\mu_0 \mu_r h}{w} \right)$$



# Comparisons

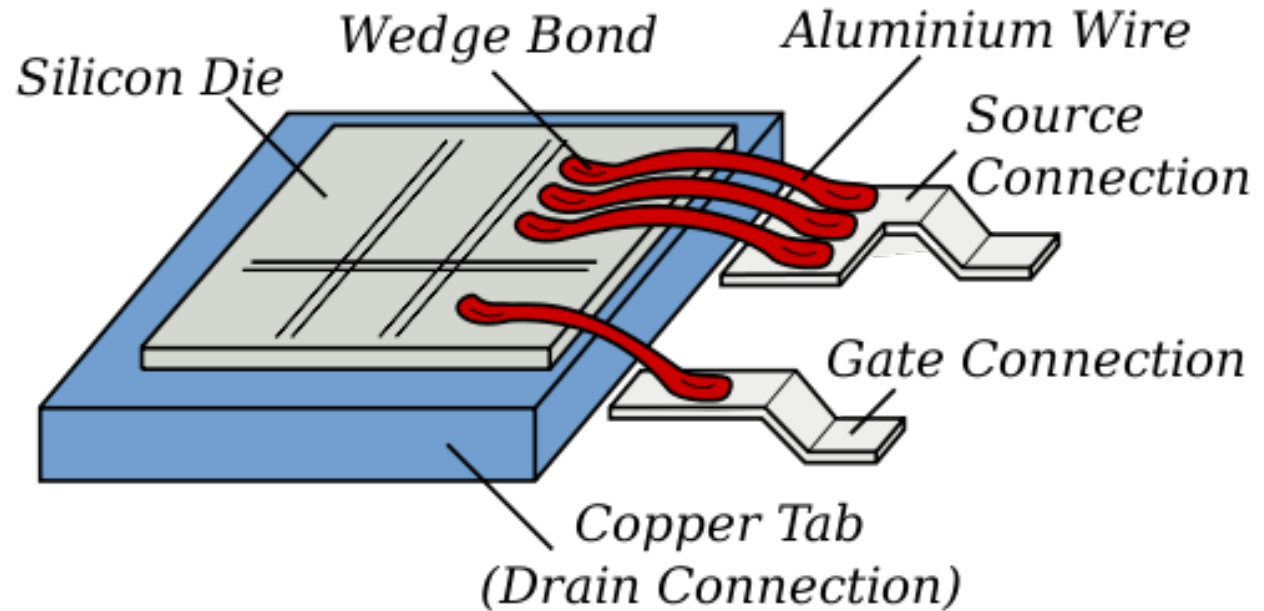
---

- 5mil trace on PCB
  - 7.56nH/cm
- Breadboard wires (0.6mm diameter)
  - About 7nH/cm
- On chip wire
  - $0.28\text{nH/mm} = 2.8\text{nH/cm}$



# Inductors

- ❑ Bond pads
- ❑ Chip leads
- ❑ Long wire runs
- ❑ Cables



Src: <http://en.wikipedia.org/wiki/File:Wirebonding2.svg>

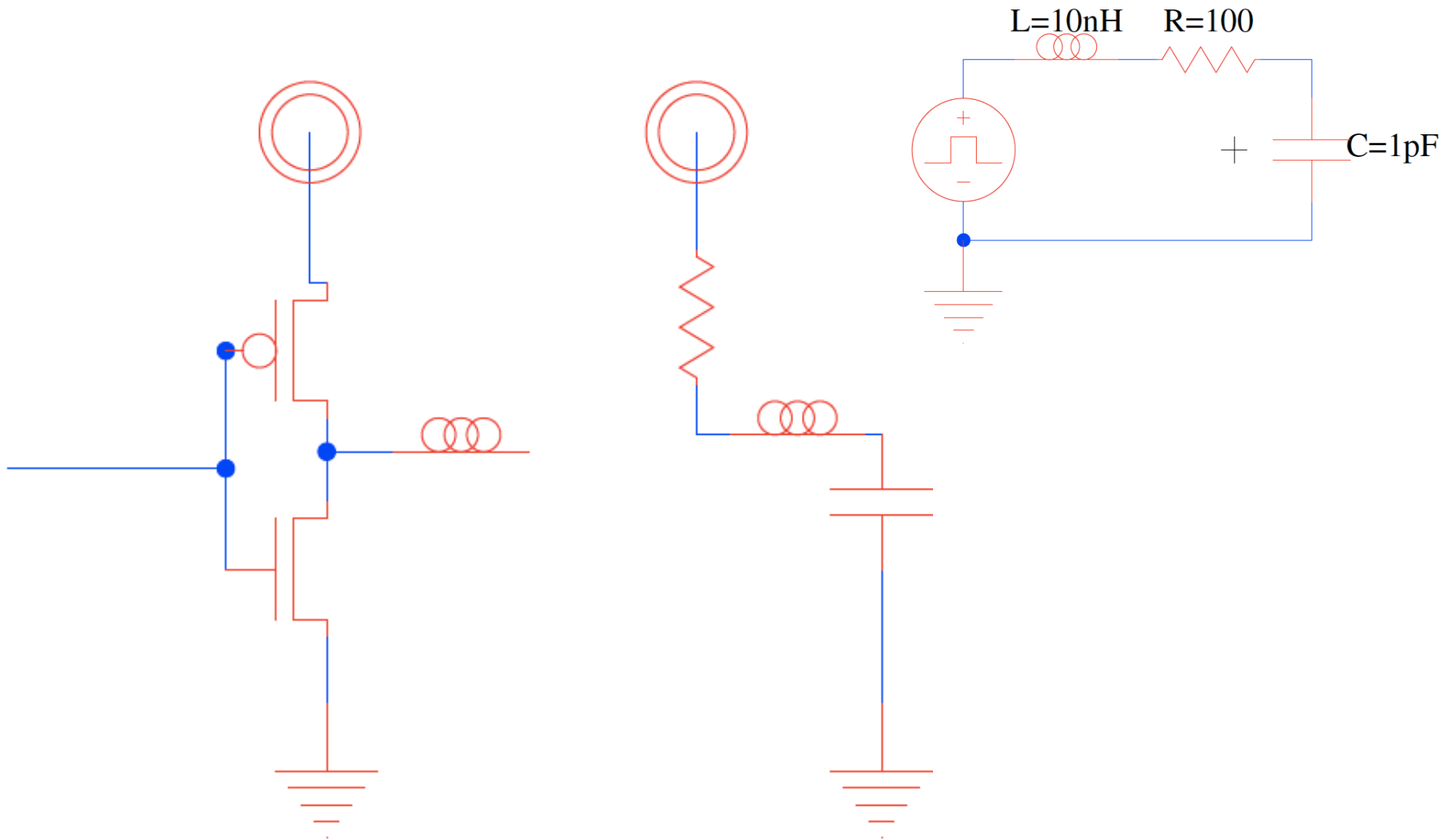
# Where Inductance Arises

---

In our digital systems

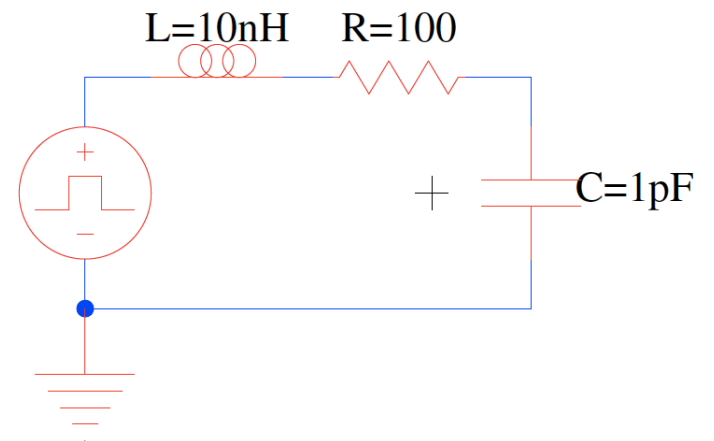
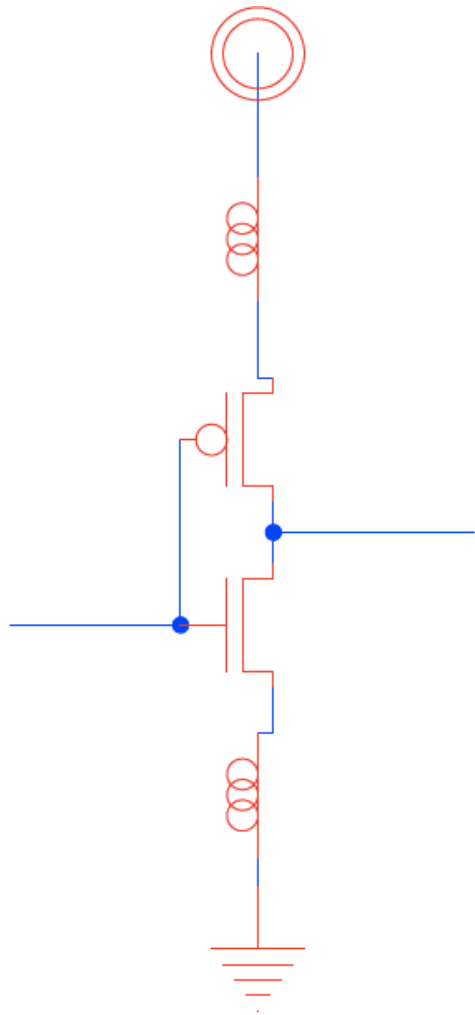


# Signal Path

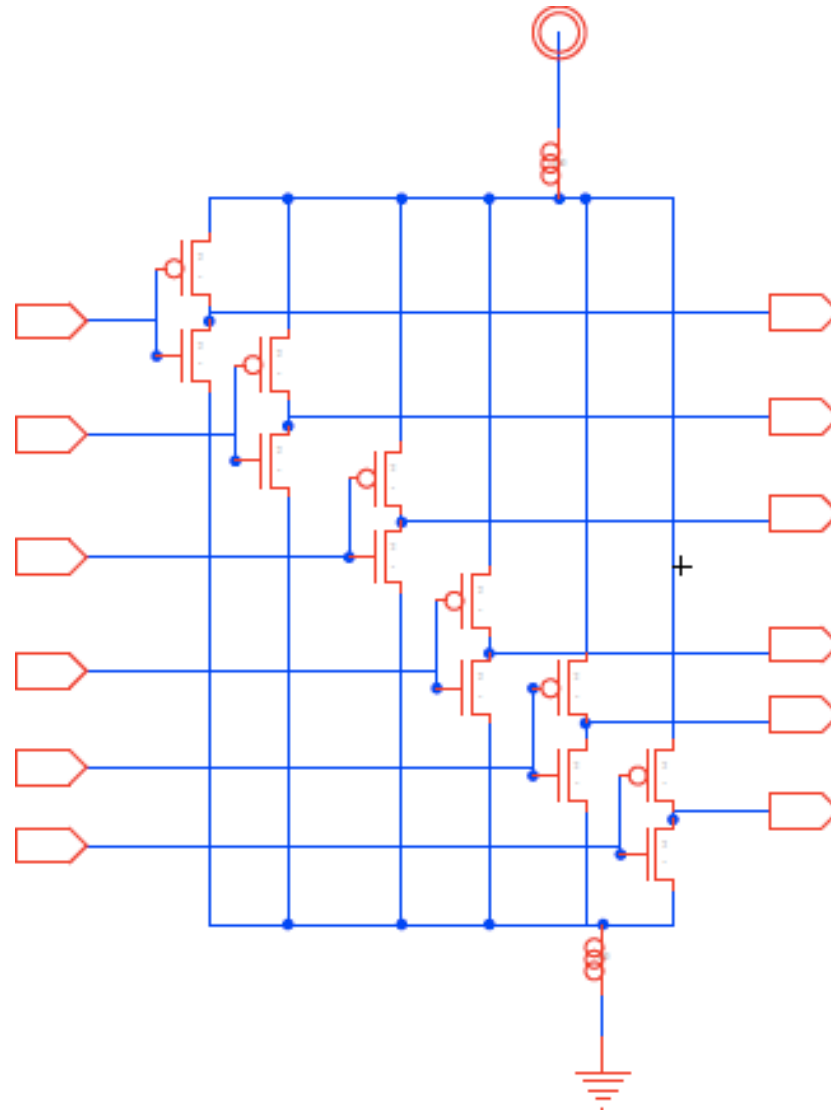




# Power Ground



# Shared Power/Ground Example: 74x04



# Estimate

- $R_{eq}, C_{eq}$  for gates in parallel
  - $R_0 = 25K \Omega$
  - $C_0 = 0.01 \text{ fF}$ 
    - say  $10C_0=0.1 \text{ fF}$  for typical load
- 250 gates switching at clock

$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{\left(j\sqrt{\frac{1}{LC}-\left(\frac{R}{2L}\right)^2}\right)t}$$

Decay	Oscillation
-------	-------------

# Estimate

- $R_{eq}, C_{eq}$  for gates in parallel
  - $R_0 = 25K \Omega$
  - $C_0 = 0.01 \text{ fF}$ 
    - say  $10C_0=0.1 \text{ fF}$  for typical load
- 250 gates switching at clock
- $R_{eq} = 100\Omega$      $C_{eq}=25 \text{ fF}$
- Assume  $L=1 \text{ nH}$
- How long to settle? Oscillation freq?

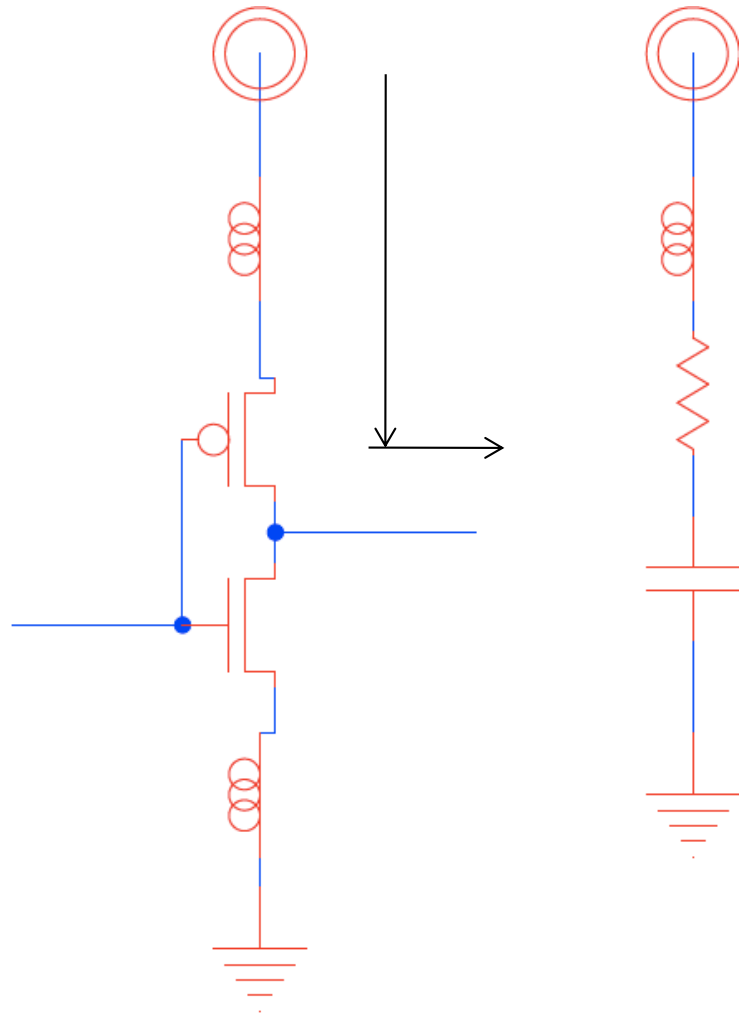
$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{\left(j\sqrt{\frac{1}{LC}-\left(\frac{R}{2L}\right)^2}\right)t}$$

Decay	Oscillation
-------	-------------



# Power Ground

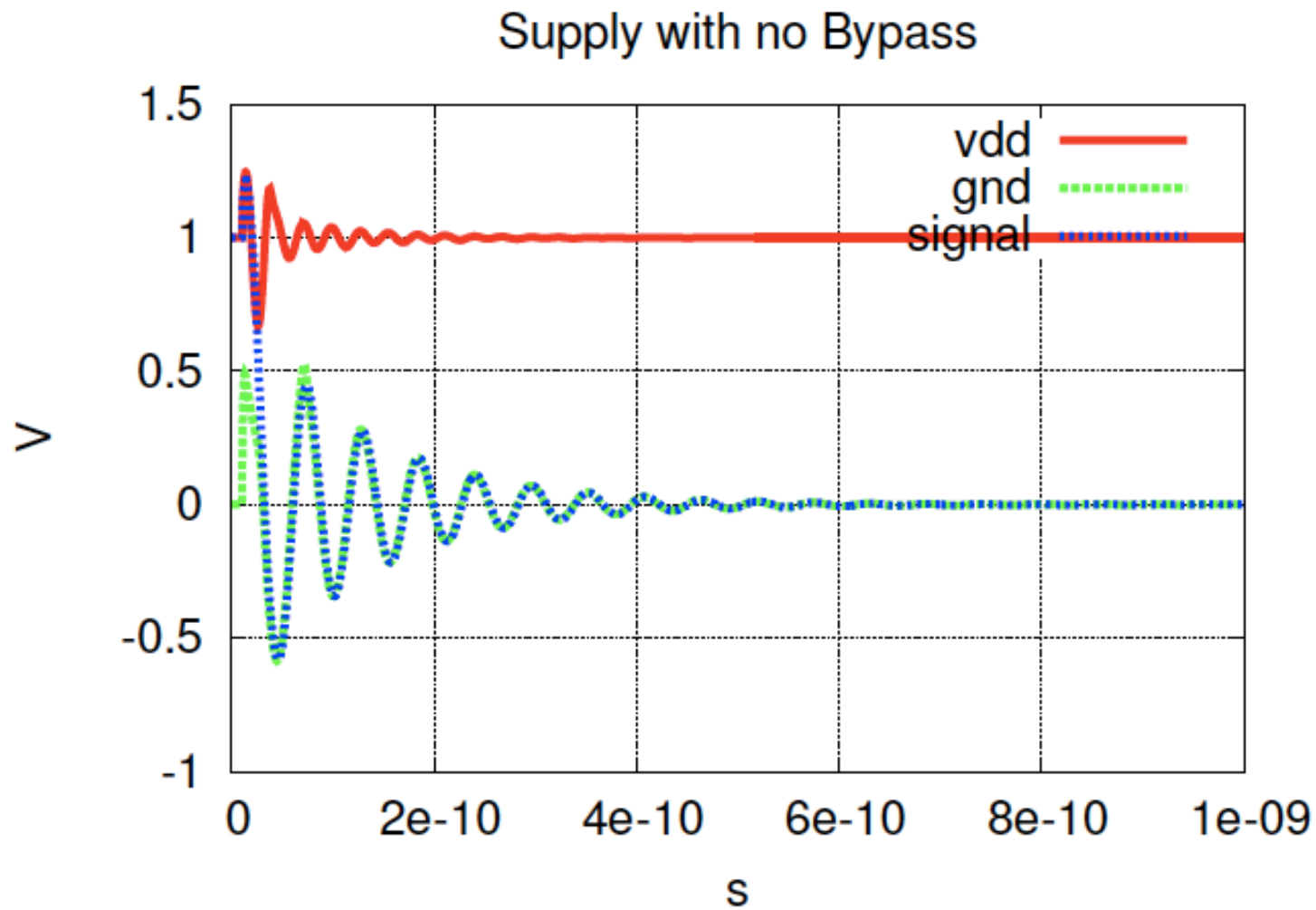
---





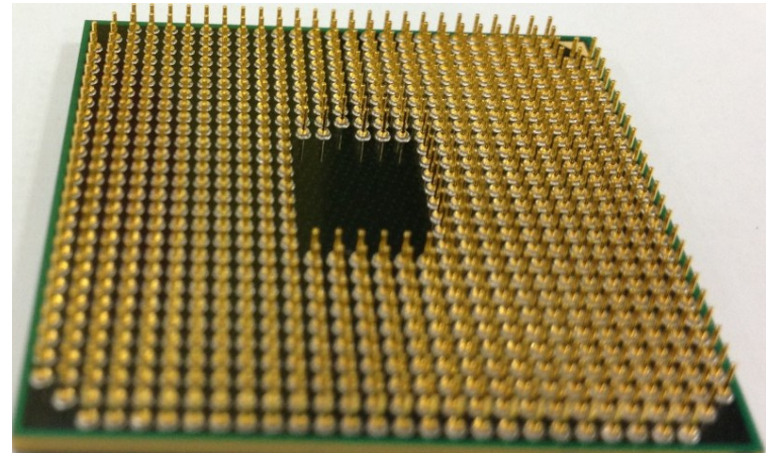


# RLC Response



# Today's chips: Multiple Power/Ground Pins

- Use many power/ground pins



- Divide switching gates by pins
  - To get effective load on each pin

# Improve Performance

---



# Minimize the L

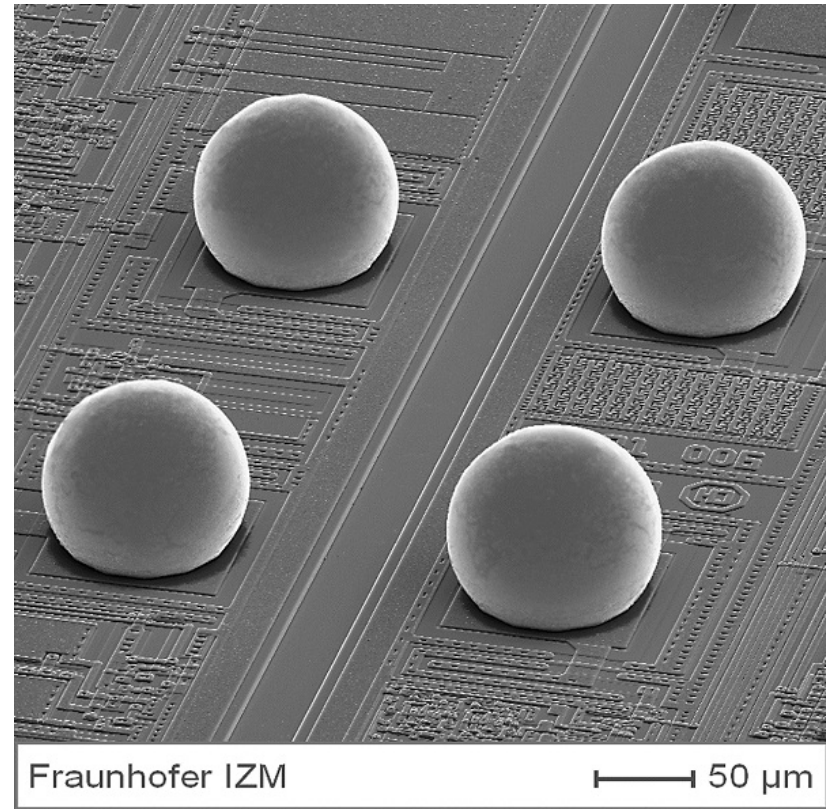
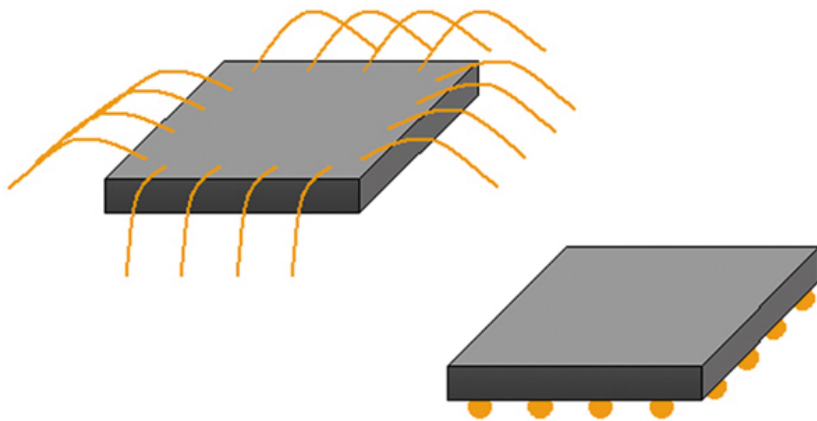
---

- ❑ Make wires short
- ❑ Use power and ground planes
  - Think of power plane as a very wide wire

$$L \approx l \left( \frac{\mu_0 \mu_r h}{w} \right)$$



# Flip Chip, Area IO



[http://www.izm.fraunhofer.de/en/abteilungen/high\\_density\\_interconnectwaferlevelpackaging/arbeitsgebiete/arbeitsgebiet1](http://www.izm.fraunhofer.de/en/abteilungen/high_density_interconnectwaferlevelpackaging/arbeitsgebiete/arbeitsgebiet1)

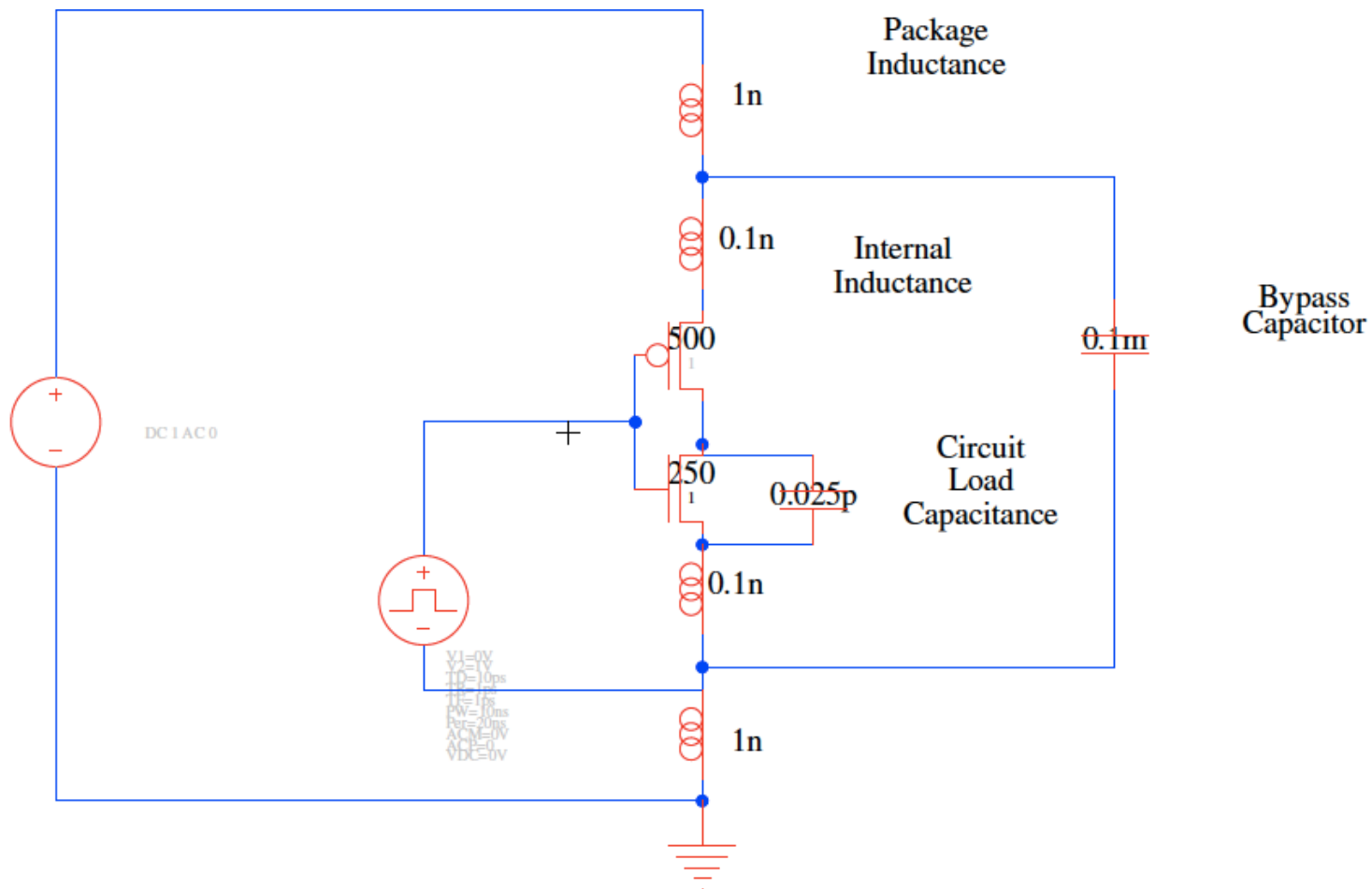
# Add Good C's

- Bypass Capacitors – inside the inductances
  - On board
  - On package
  - On chip

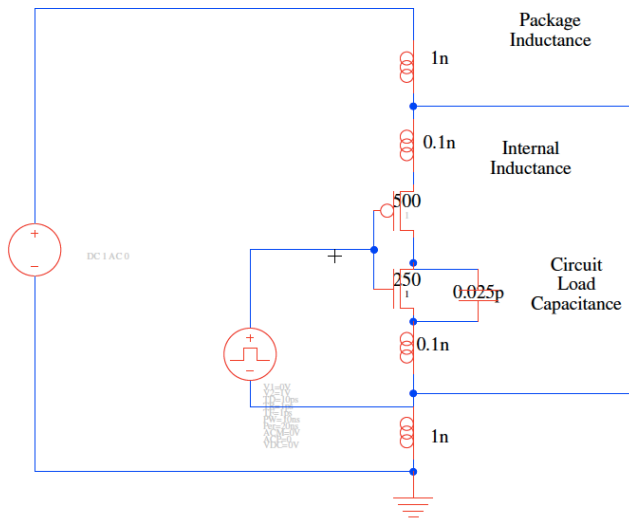




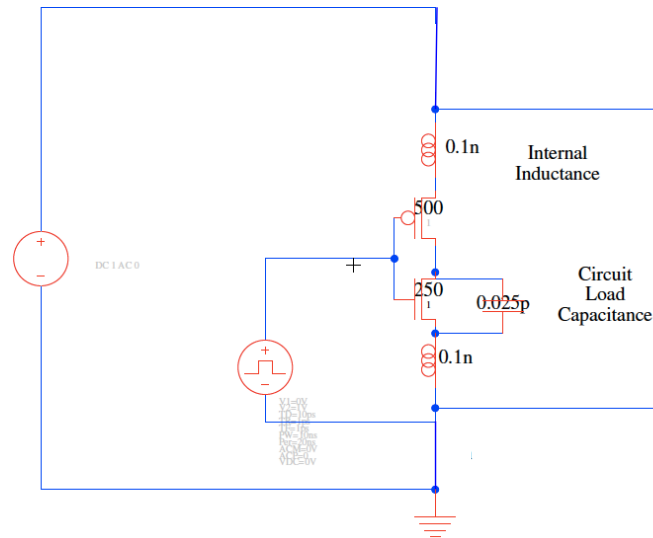
# Bypass Capacitor Example



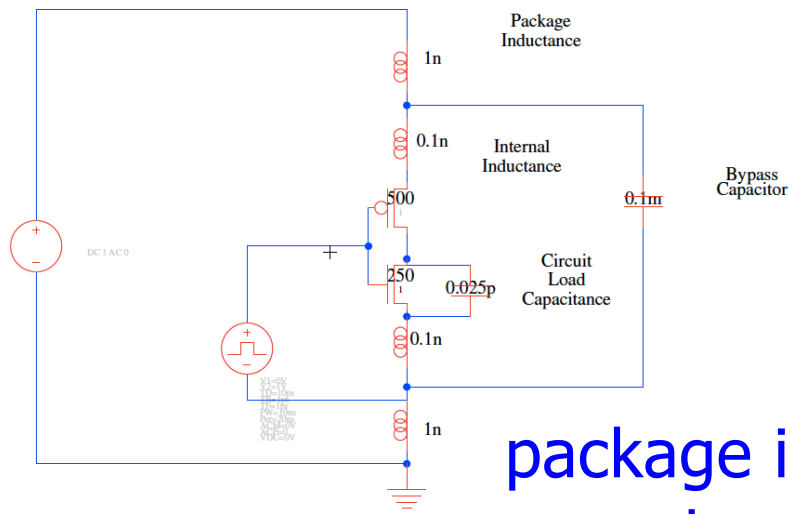
# Bypass Capacitor Example



No bypass cap



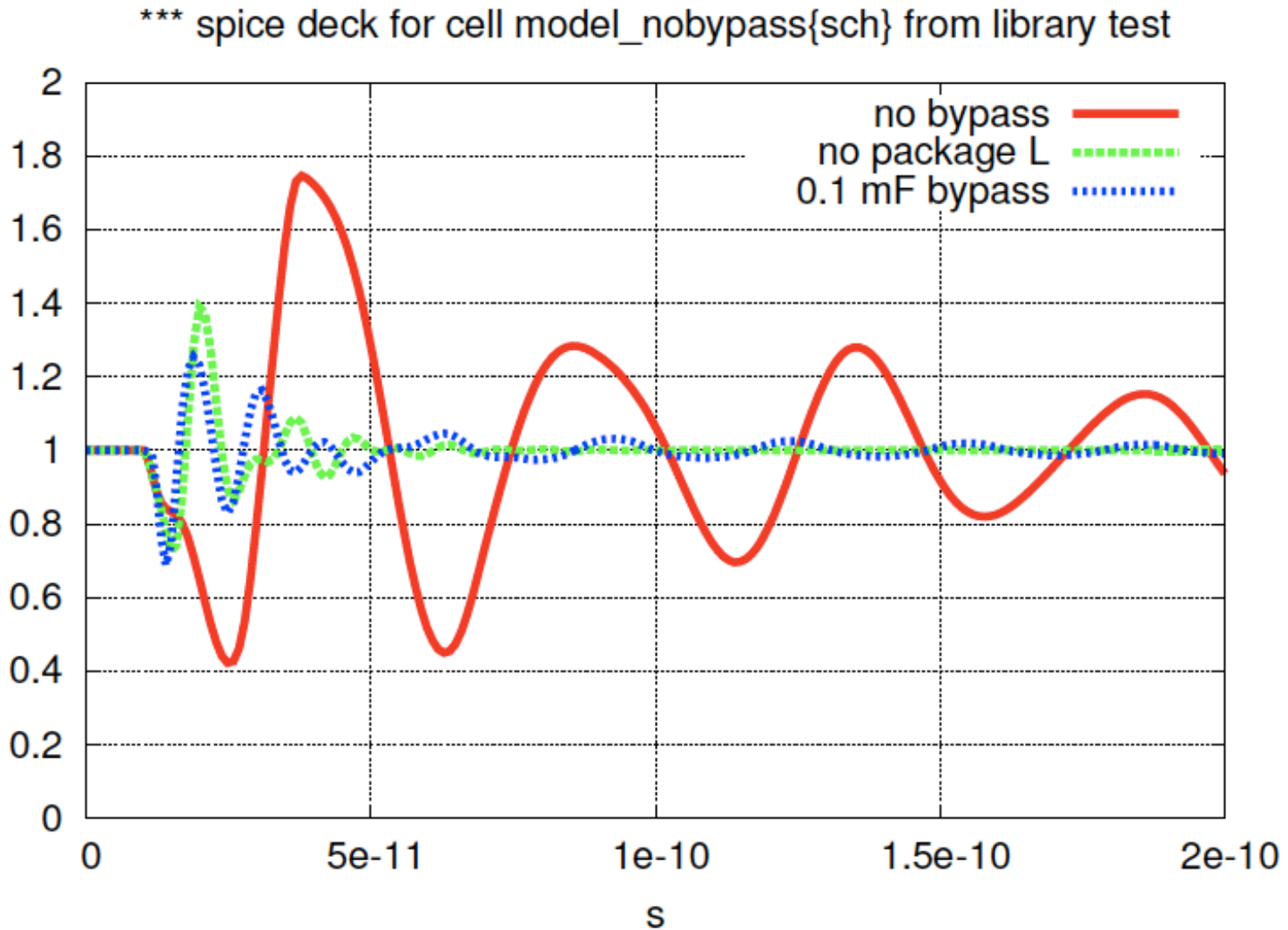
No package inductance



package inductance w/  
bypass cap

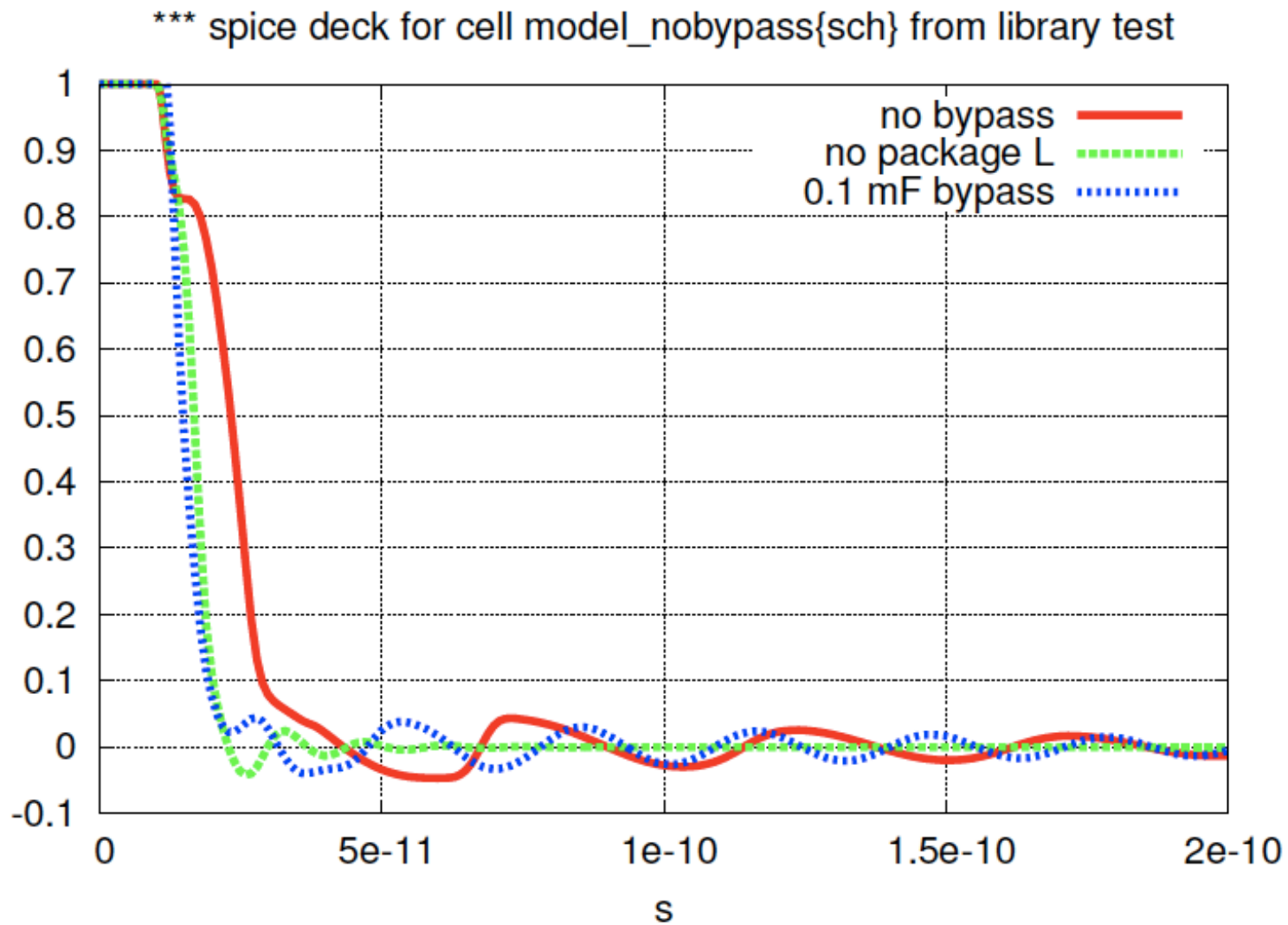


# Bypassed Supplies (@ transistor)





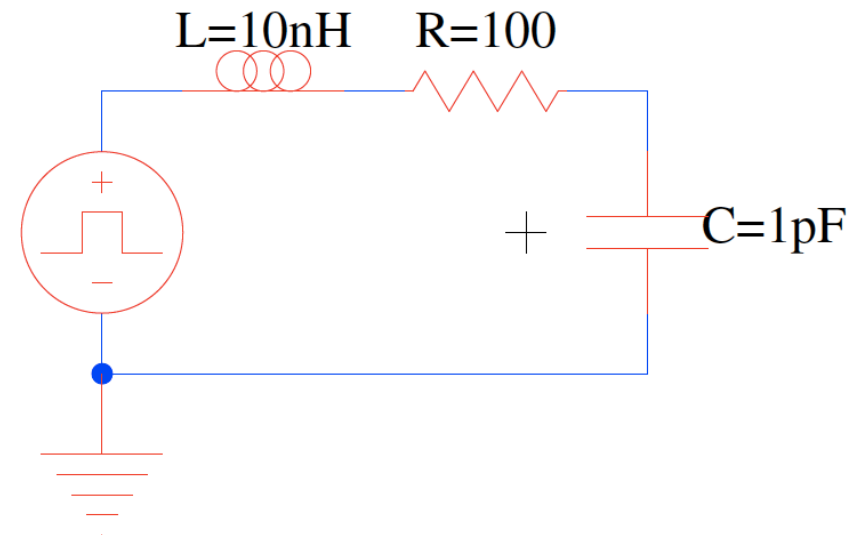
# Bypassed Output



# Idea

- ❑ Long wires are inductive
  - **Avoid** them
  - Especially on power supplies
- ❑ Bypass capacitors help

$$V_2 = V_S + B e^{\left(-\frac{R}{2L}\right)t} e^{\left(j\sqrt{\frac{1}{LC} - \left(\frac{R}{2L}\right)^2}\right)t}$$





# Admin

---

- Project 2
  - Milestone due Monday
    - Feedback by Wednesday
  - Final due Friday 12/3